

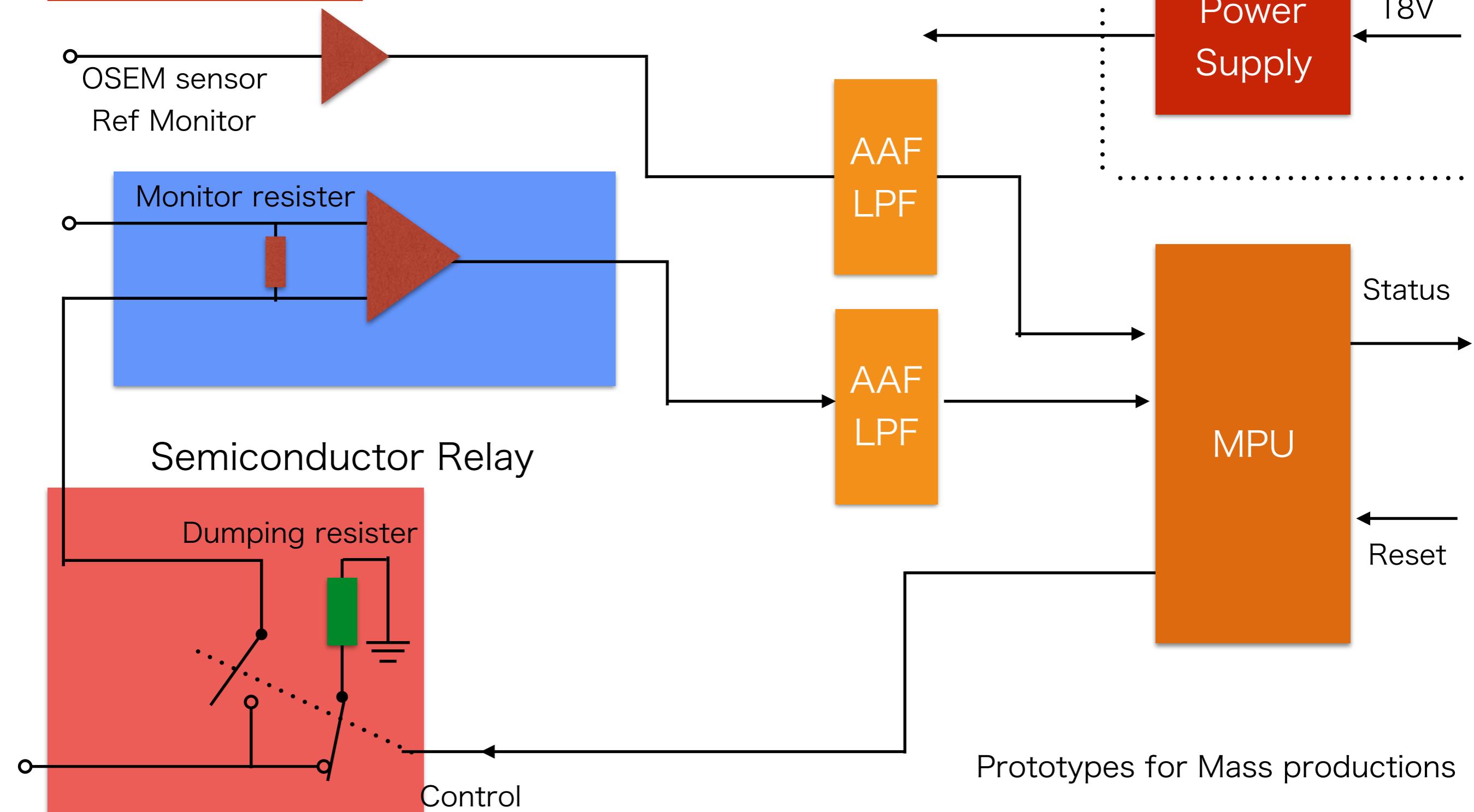
Project-WDS  
2016/04/01

GW  
Nobuyuki Tanaka

## 5th System Design Type D

15/12/04 Ver1

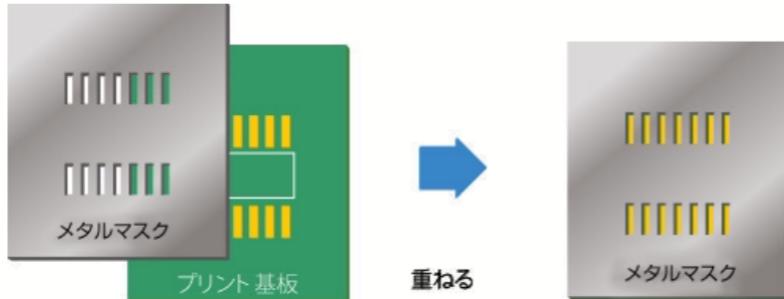
Watchdog system  
異常検出・安全装置



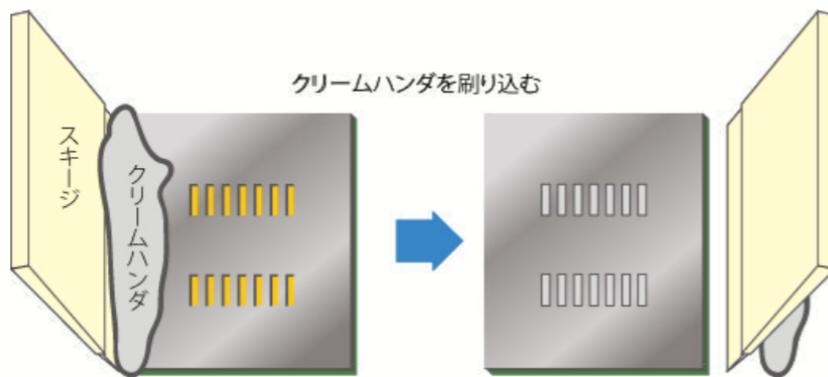
## Reflow soldering process

## Watchdog system 異常検出・安全装置

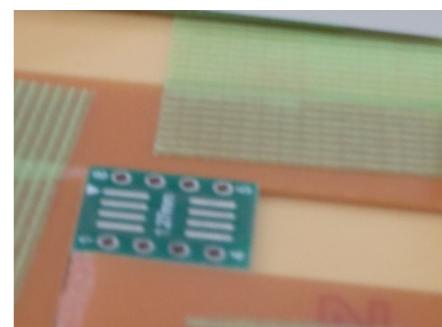
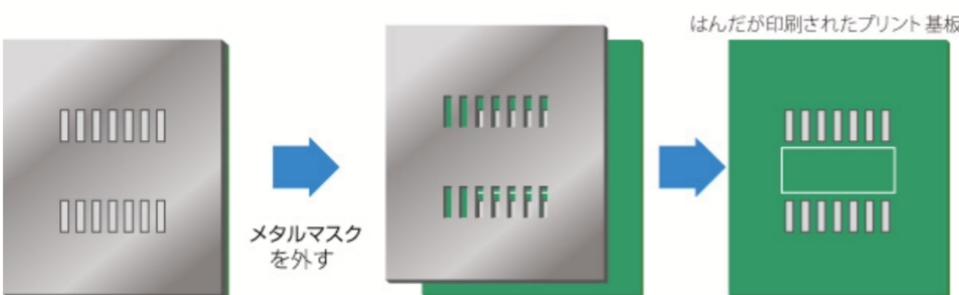
手順1 メタルマスクとプリント基板を重ねます。



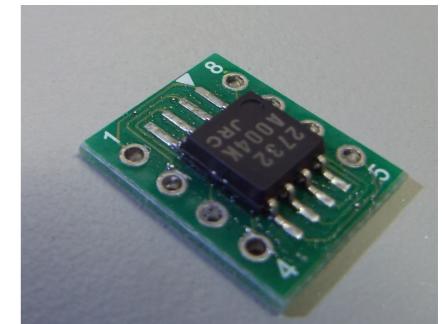
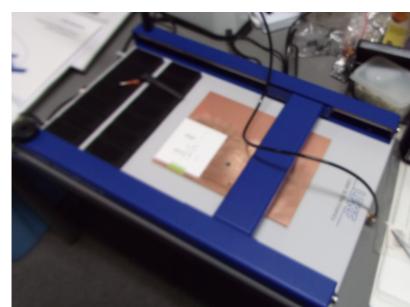
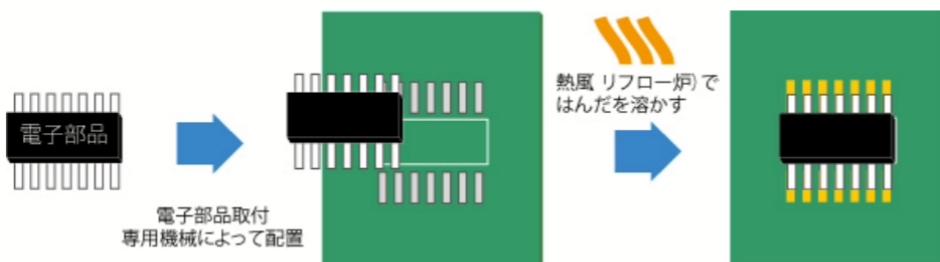
手順2 クリーム状のハンダを流し込み、スキージと呼ばれるヘラで刷り込みます。



そしてメタルマスクを取り除くと、必要な所にだけハンダが印刷されることになります。

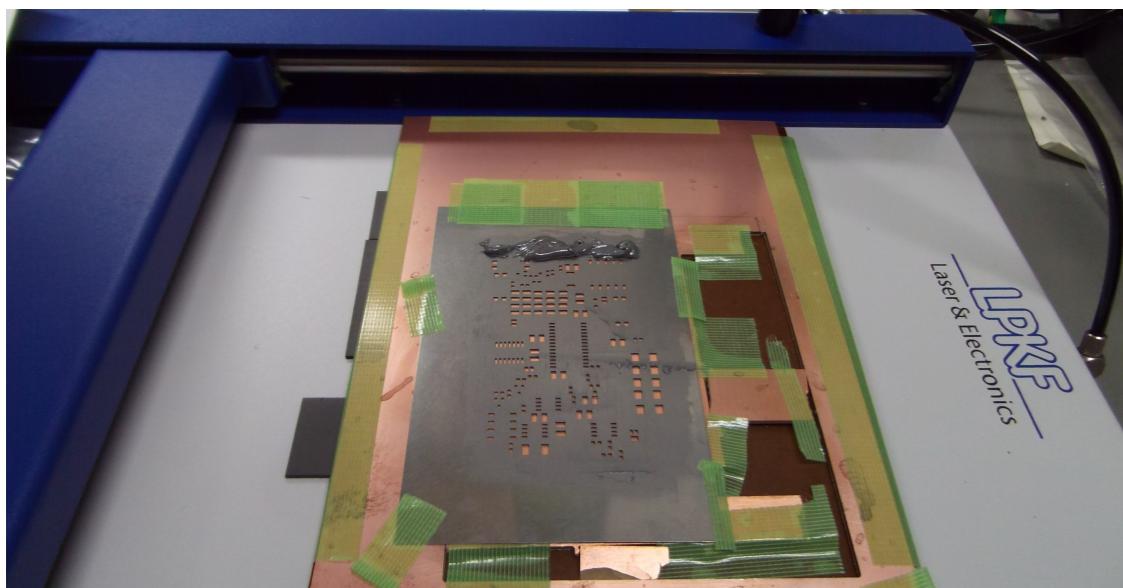


手順3 電子部品取付 専用機械（実装機械）によって電子部品をハンダ上に配置し、熱風（リフロー炉）によって、ハンダを溶かしてプリント基板と電子部品をプリント基板の表側で接続します。

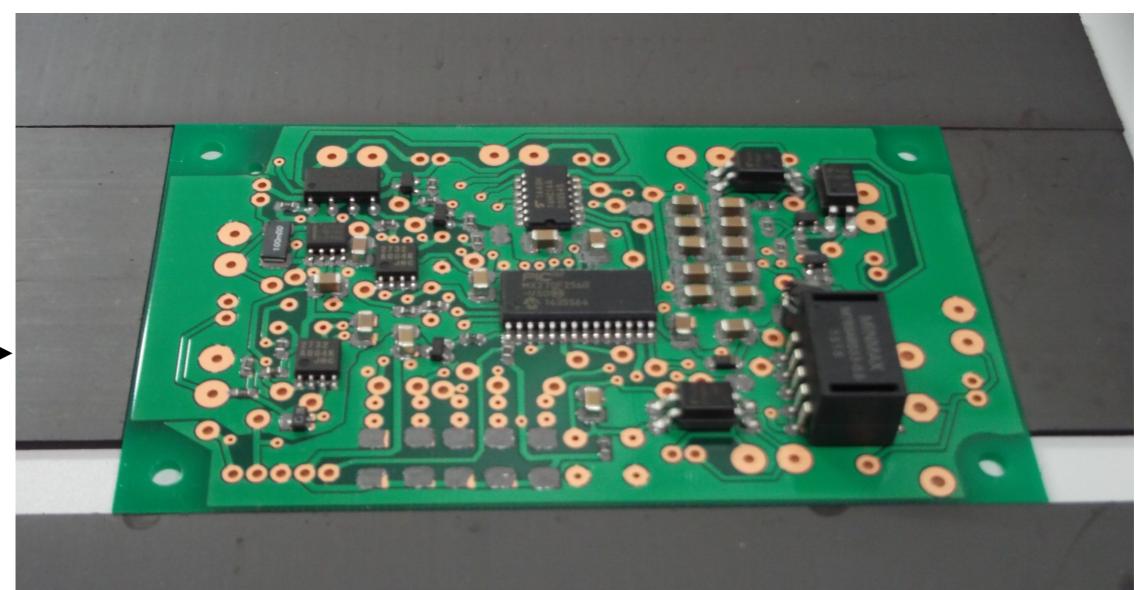
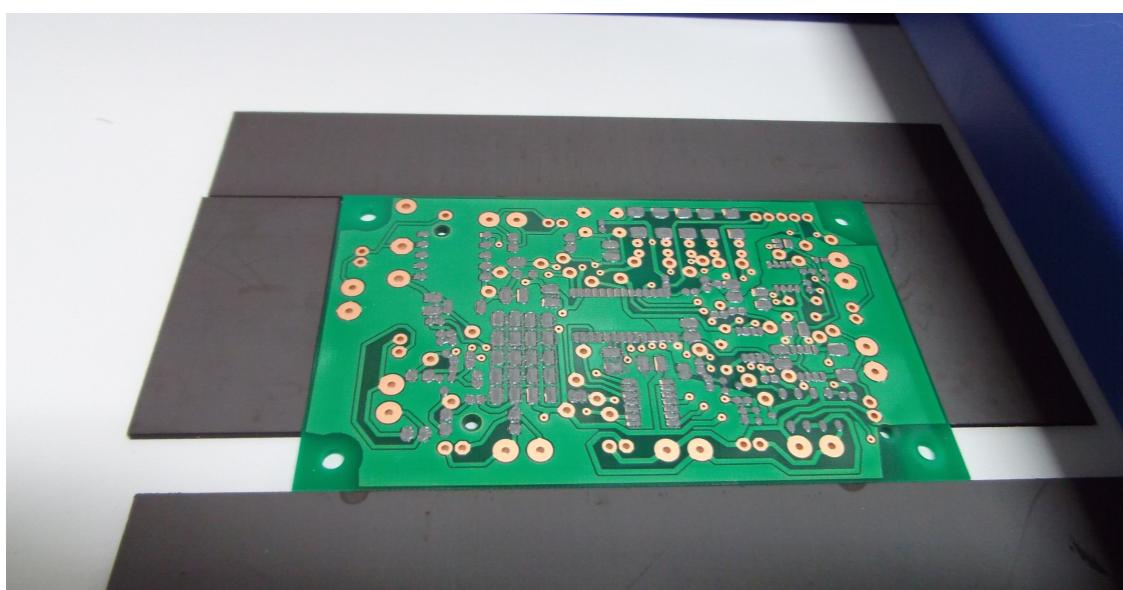
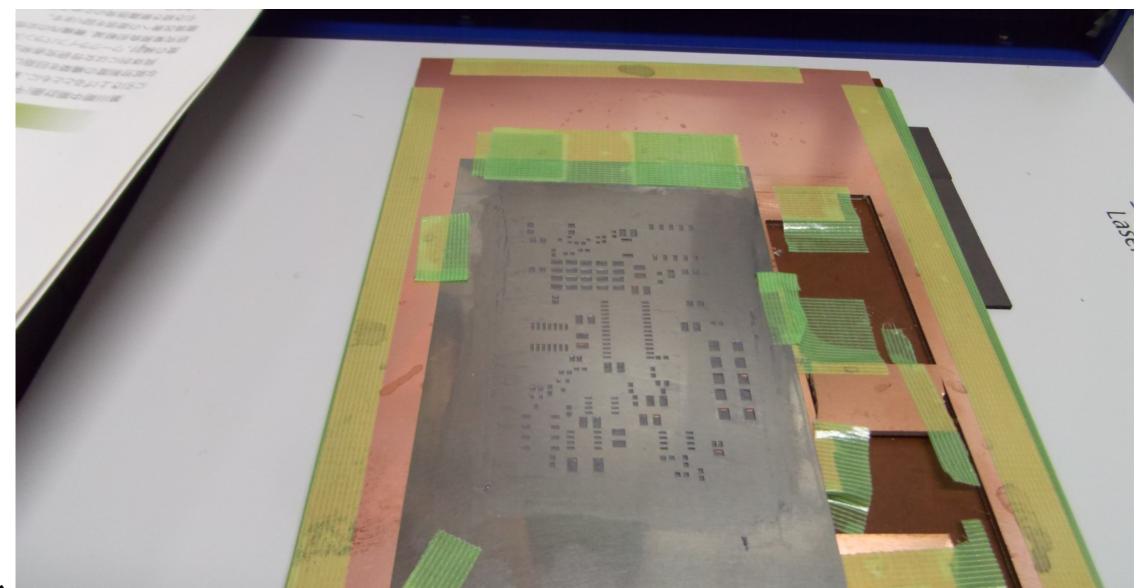


Watchdog system  
異常検出・安全装置

Production process by reflow oven



Printing solder paste



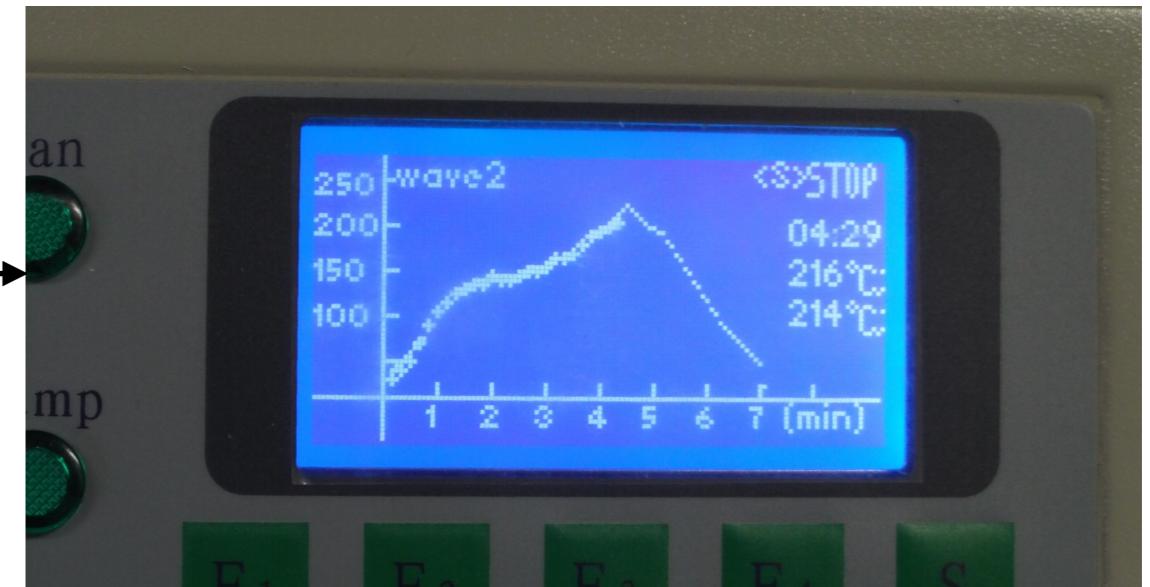
Mounting on SMD

# Watchdog system 異常検出・安全装置

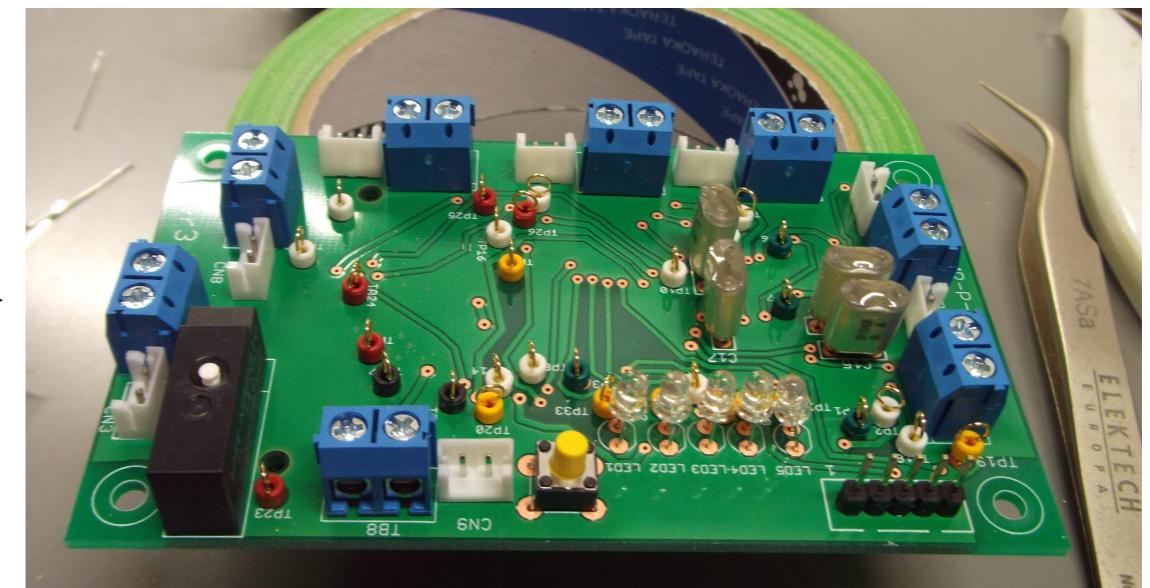
## Production process by reflow oven



Heating by Reflow oven.



Heating temperature profile



To implement the parts.

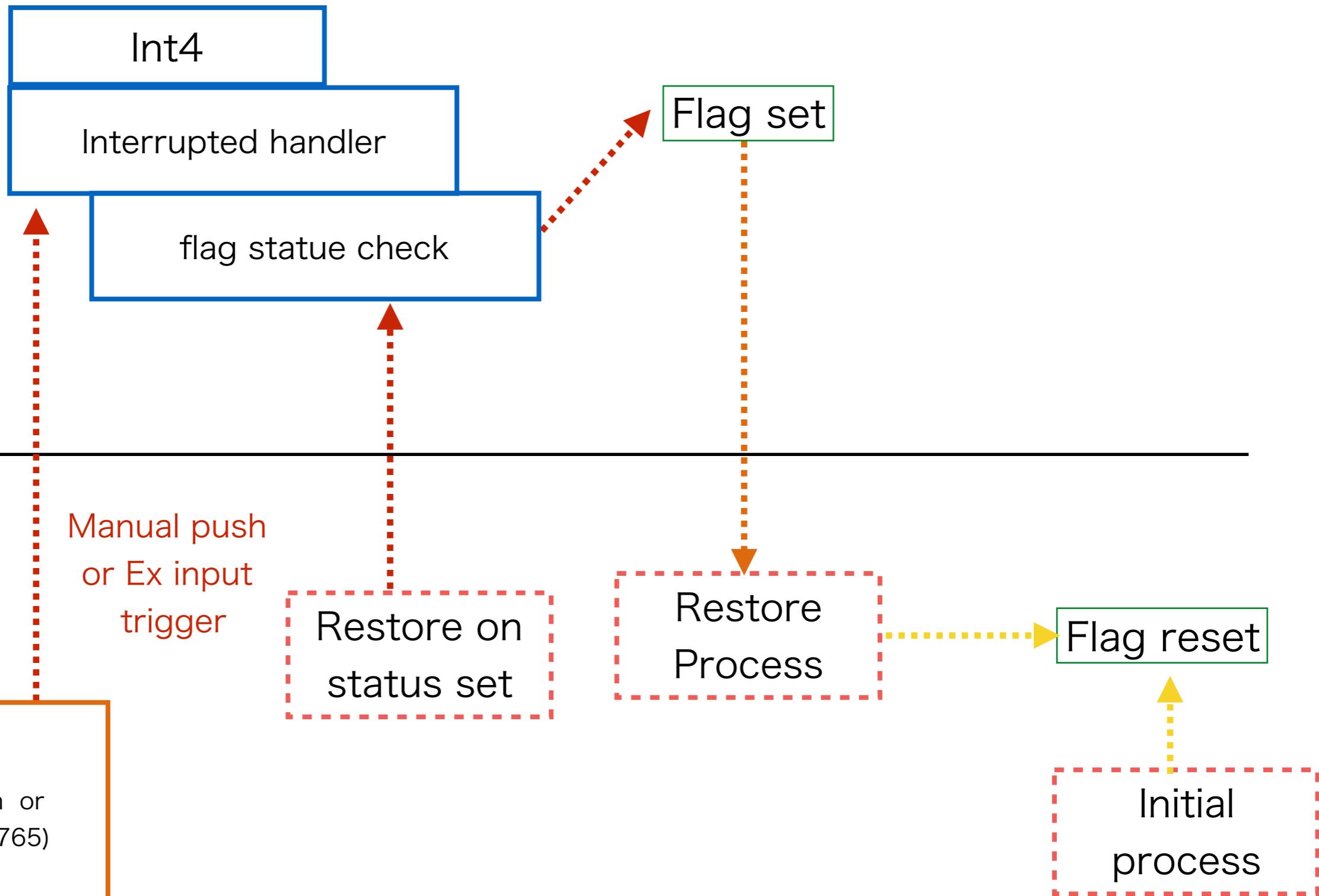
Watchdog system  
異常検出・安全装置

I/O Direction	PIN number	PIN assignment
Output(Digital)	RB5(14)	Break on/PhMOS on
Output(Digital)	RB8(17)	Live
Output(Digital)	RB10(21)	LED1
Output(Digital)	RB11(22)	LED2
Output(Digital)	RB13(24)	LED3
Output(Digital)	RB14(25)	LED4
Output(Digital)	RB15(26)	LED5
Input(Digital)	RB7(16)	Restore/INT4
Input(Analog)	AN4(6)	OSEM sensor out
Input(Analog)	AN5(7)	Coil monitor R

## S/W Design

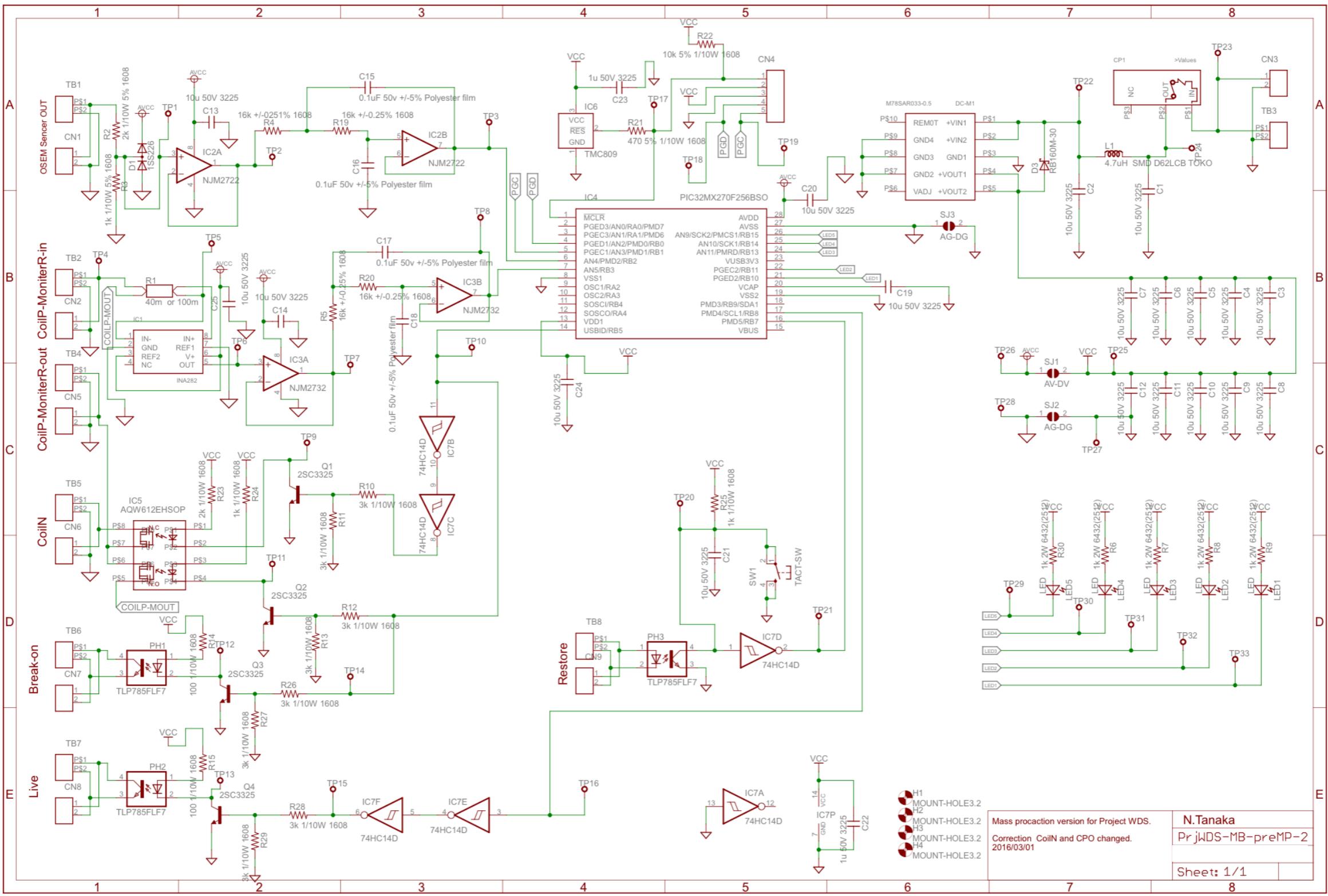
INT4

## Watchdog system 異常検出・安全装置



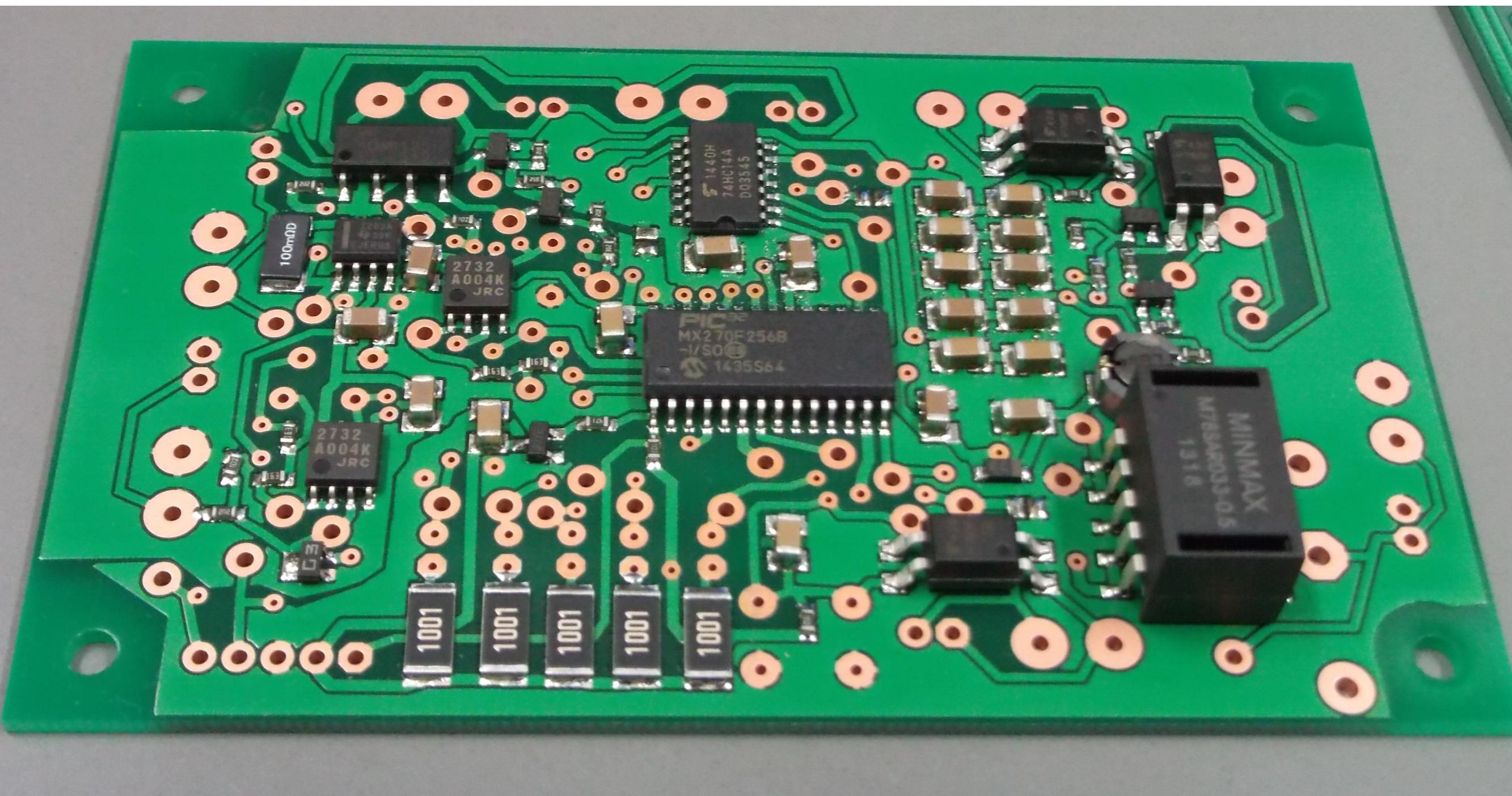
# Watchdog system

## 異常検出・安全装置



# Watchdog system

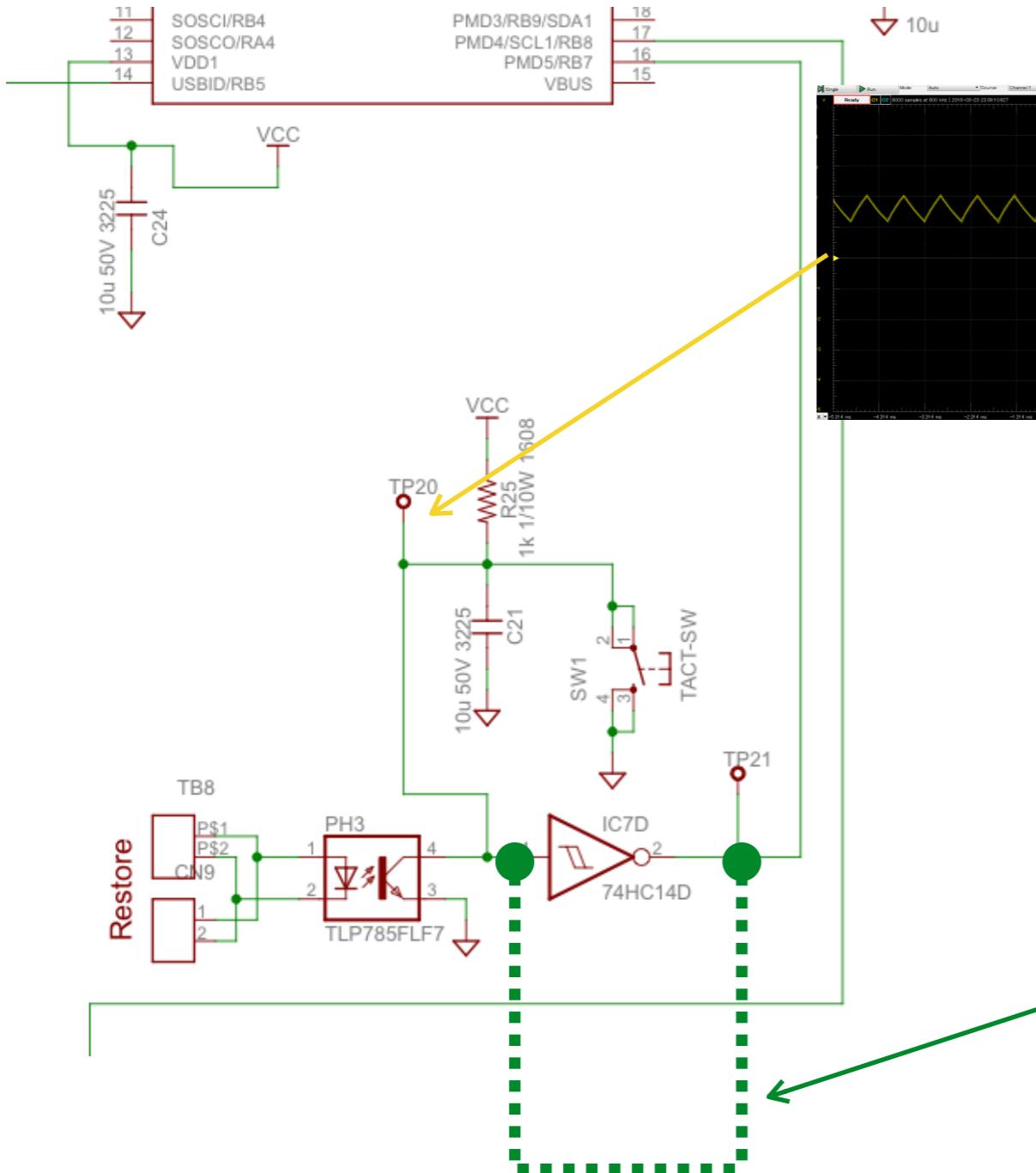
## 異常検出・安全装置



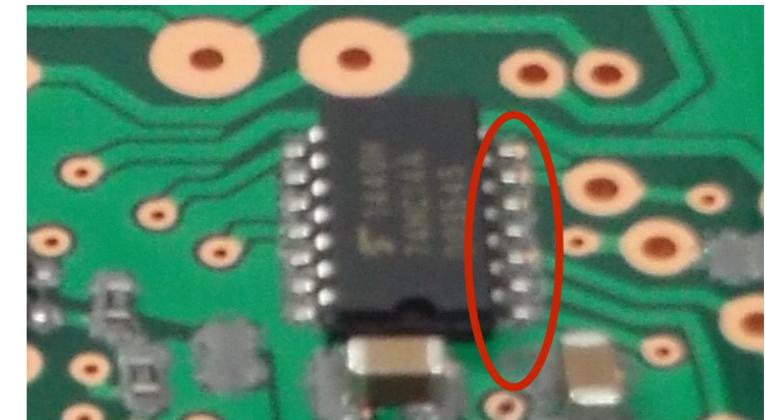
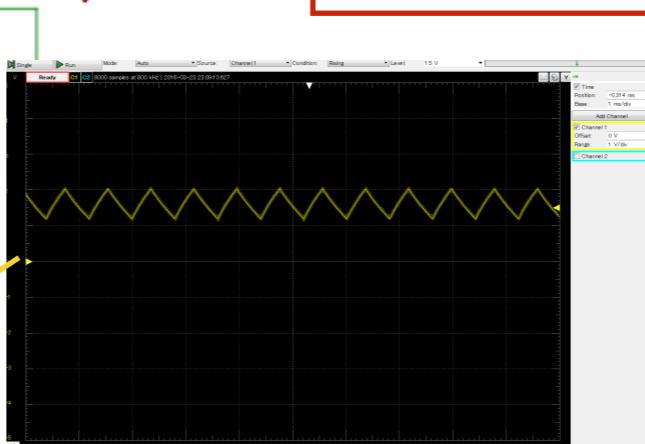
# Watchdog system

## 異常検出・安全装置

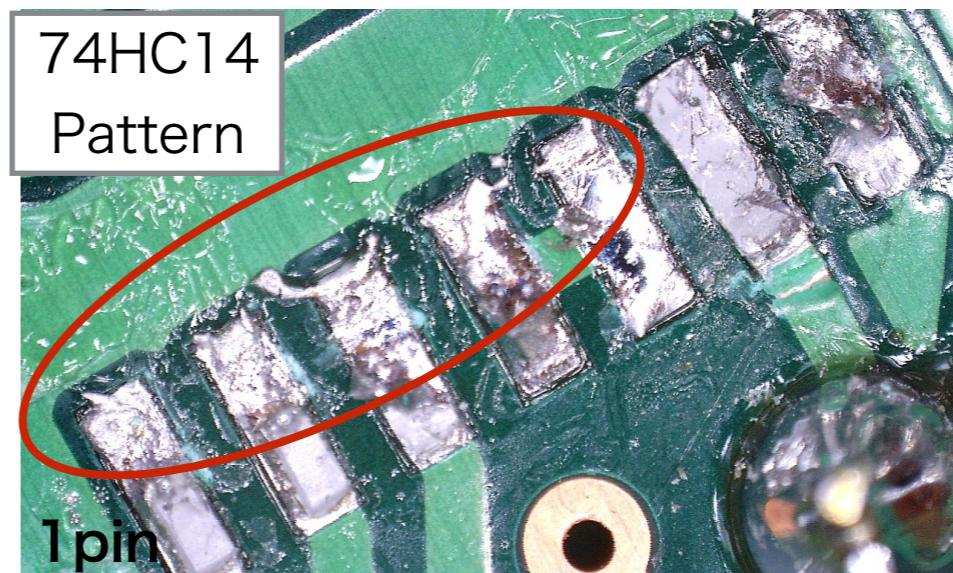
### Trouble on the production



Abnormal oscillation



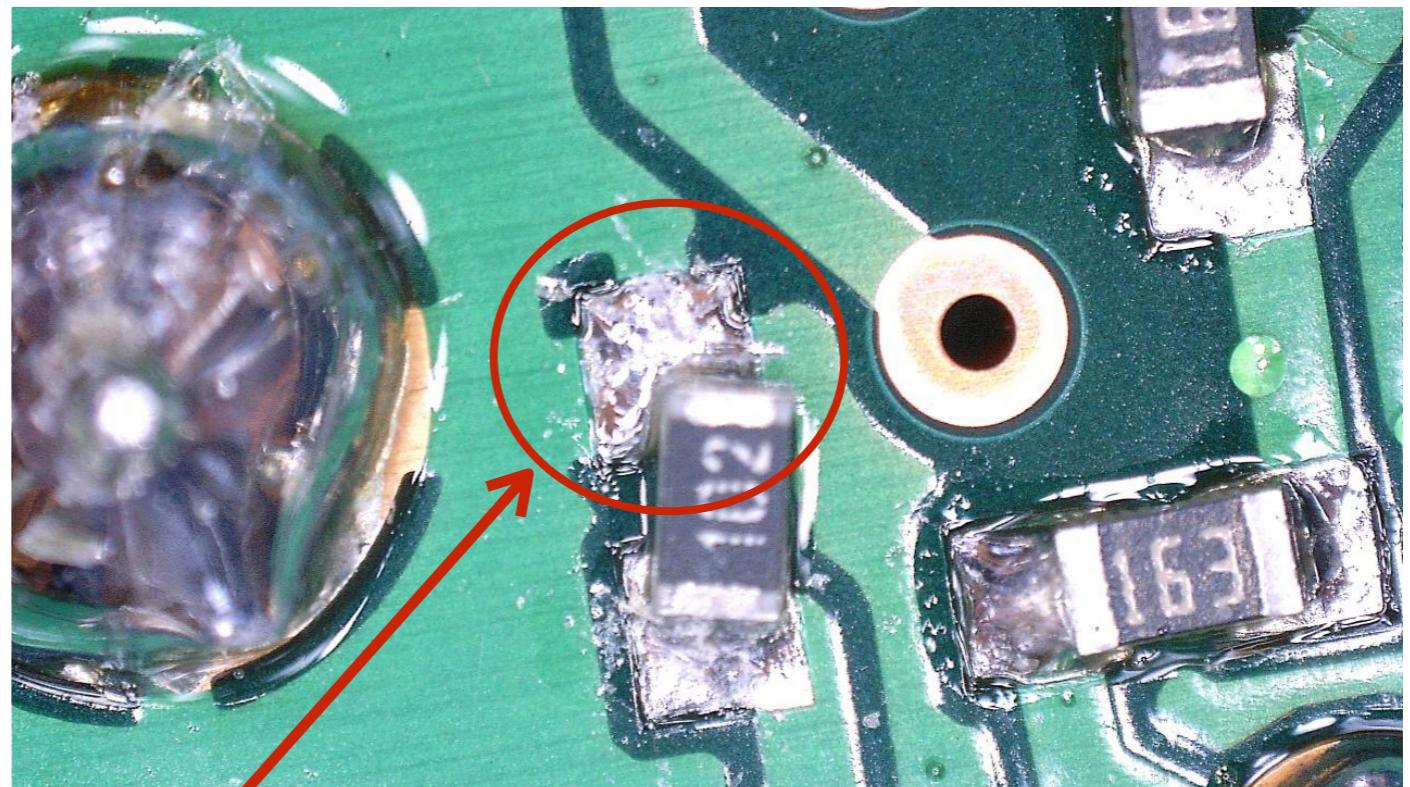
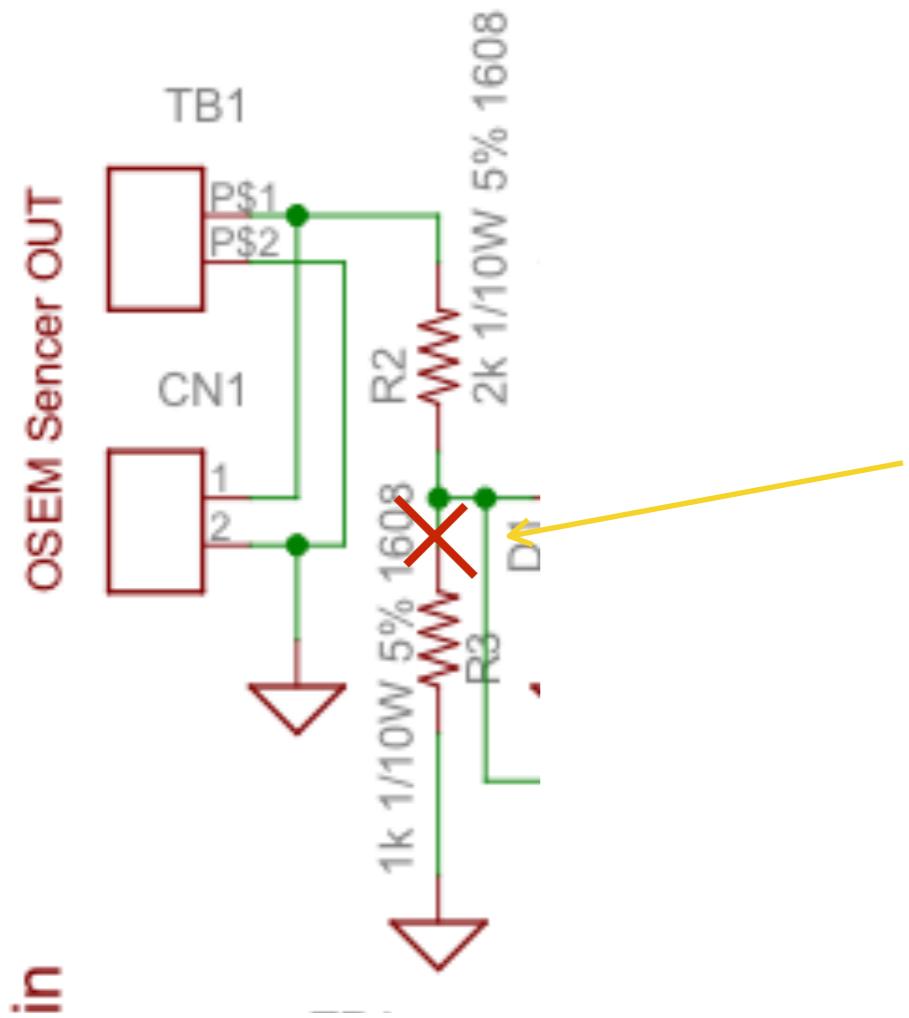
74HC14  
Pattern



Watchdog system  
異常検出・安全装置

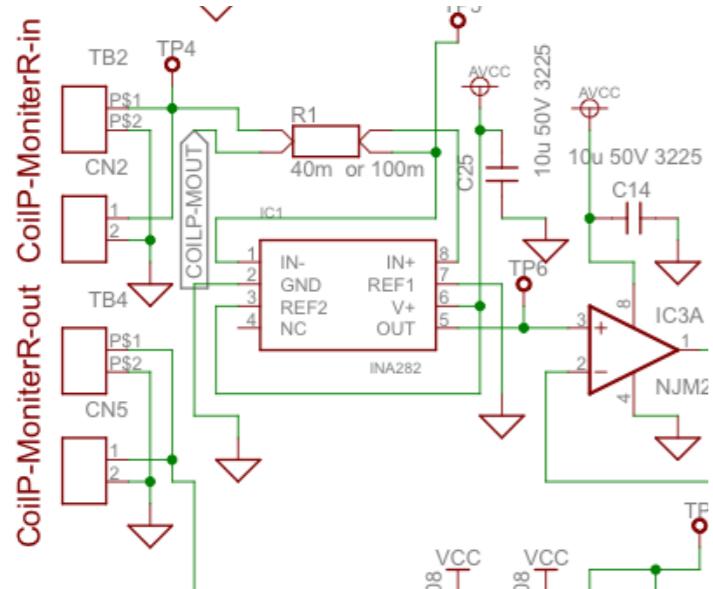
Trouble on the production

OSEM Input is divided by resistors R2 and R3.



cause: defective soldering of R3.

## Current-Shunt Monitor



Watchdog system  
異常検出・安全装置

For Low Power  
R1:100mΩ

INA283 G:200

For High Power  
R1:40mΩ

R1:100mΩ

INA282 G:50



# Design datas

## Watchdog system 異常検出・安全装置

### Current-Shunt Monitor



www.ti.com

SBOS485B –NOVEMBER 2009–REVISED SEPTEMBER 2012

#### High-Accuracy, Wide Common-Mode Range, Bi-Directional CURRENT SHUNT MONITOR Zero-Drift Series

Check for Samples: [INA282](#), [INA283](#), [INA284](#), [INA285](#), [INA286](#)

#### FEATURES

- WIDE COMMON-MODE RANGE: -14V to 80V
- OFFSET VOLTAGE:  $\pm 20\mu\text{V}$
- CMRR: 140dB
- ACCURACY:
  - $\pm 1.4\%$  Gain Error (Max)
  - $0.3\mu\text{V}/^\circ\text{C}$  Offset Drift
  - $0.005\%/\text{C}$  Gain Drift (Max)
- AVAILABLE GAINS:
  - 50V/V: INA282
  - 100V/V: INA286
  - 200V/V: INA283
  - 500V/V: INA284
  - 1000V/V: INA285
- QUIESCENT CURRENT: 900 $\mu\text{A}$  (Max)

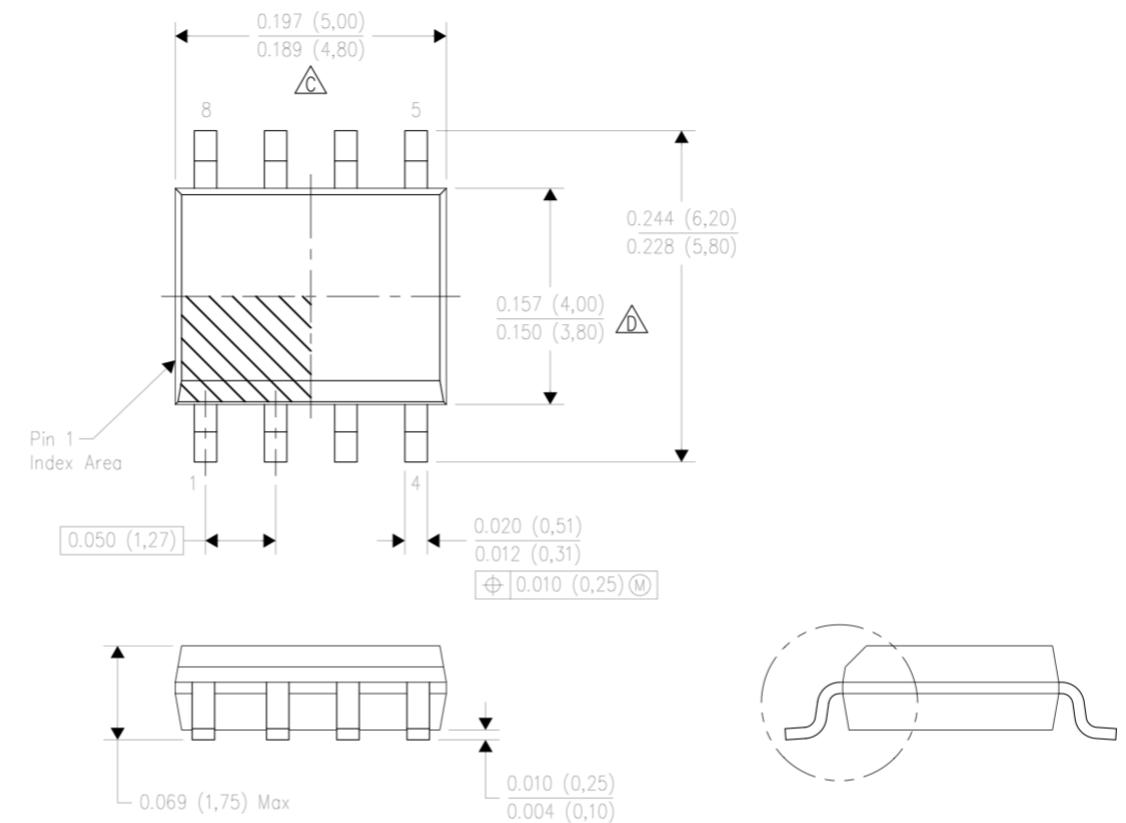
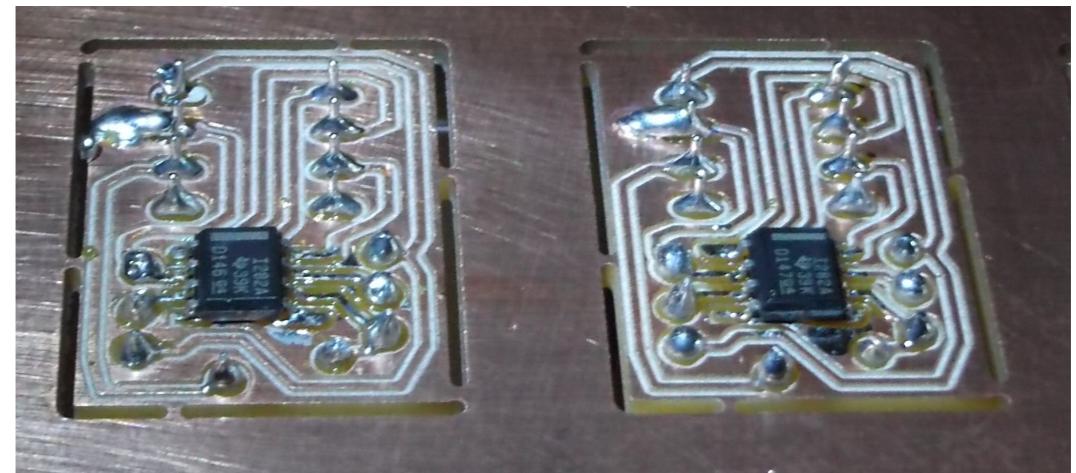
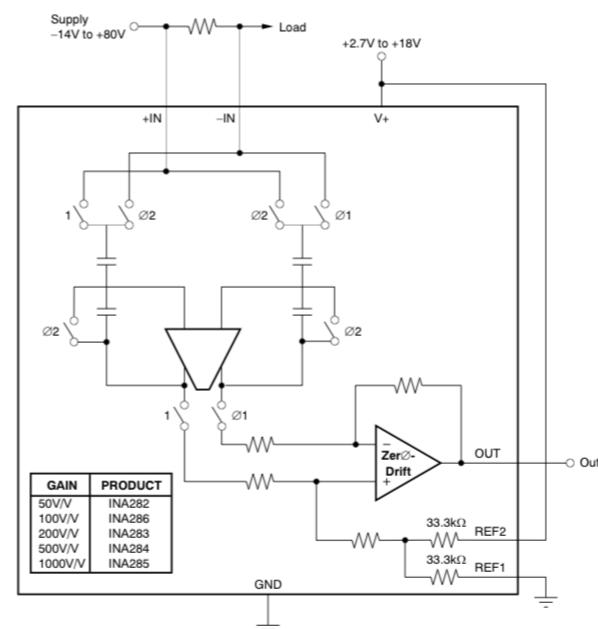
#### APPLICATIONS

- TELECOM EQUIPMENT
- AUTOMOTIVE
- POWER MANAGEMENT
- SOLAR INVERTERS

#### DESCRIPTION

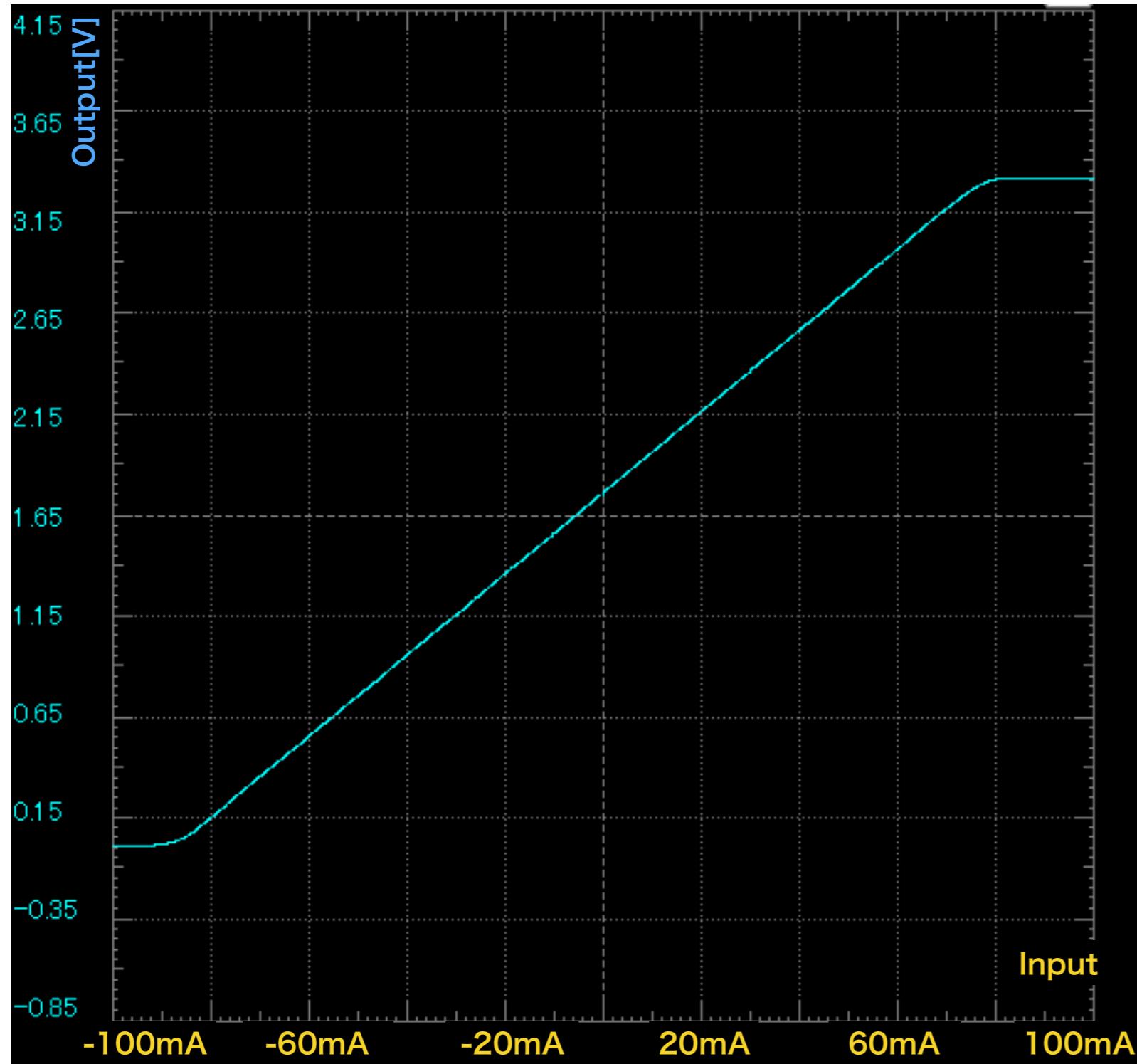
The INA282 family, which includes the INA282, INA283, INA284, INA285, and INA286 devices, are voltage output current shunt monitors that can sense drops across shunts at common-mode voltages from -14V to +80V, independent of the supply voltage. The low offset of the Zero-Drift architecture enables current sensing with maximum drops across the shunt as low as 10mV full-scale.

These current shunt monitors operate from a single +2.7V to +18V supply, drawing a maximum of 900 $\mu\text{A}$  of supply current. They are specified over the extended operating temperature range of -40°C to +125°C, and offered in an SOIC-8 package.



Watchdog system  
異常検出・安全装置

Current shunt monitor Input-Output  
Characteristic



For Low Power

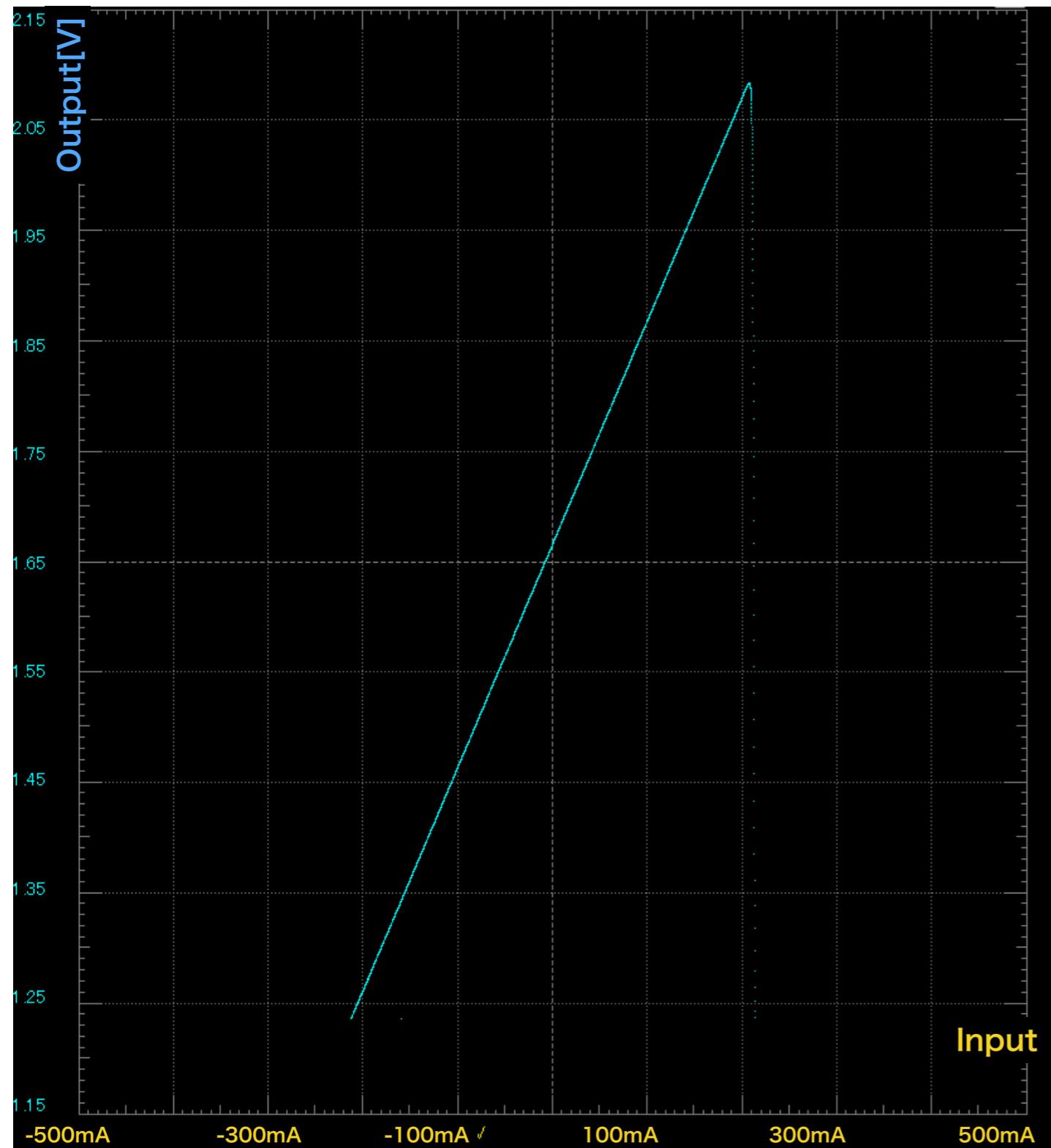
R1:100mΩ

INA283 G:200

0mA ≈ 1.75V

Watchdog system  
異常検出・安全装置

Current shunt monitor Input-Output  
Characteristic



For High Power

R1:40mΩ

INA282 G:50

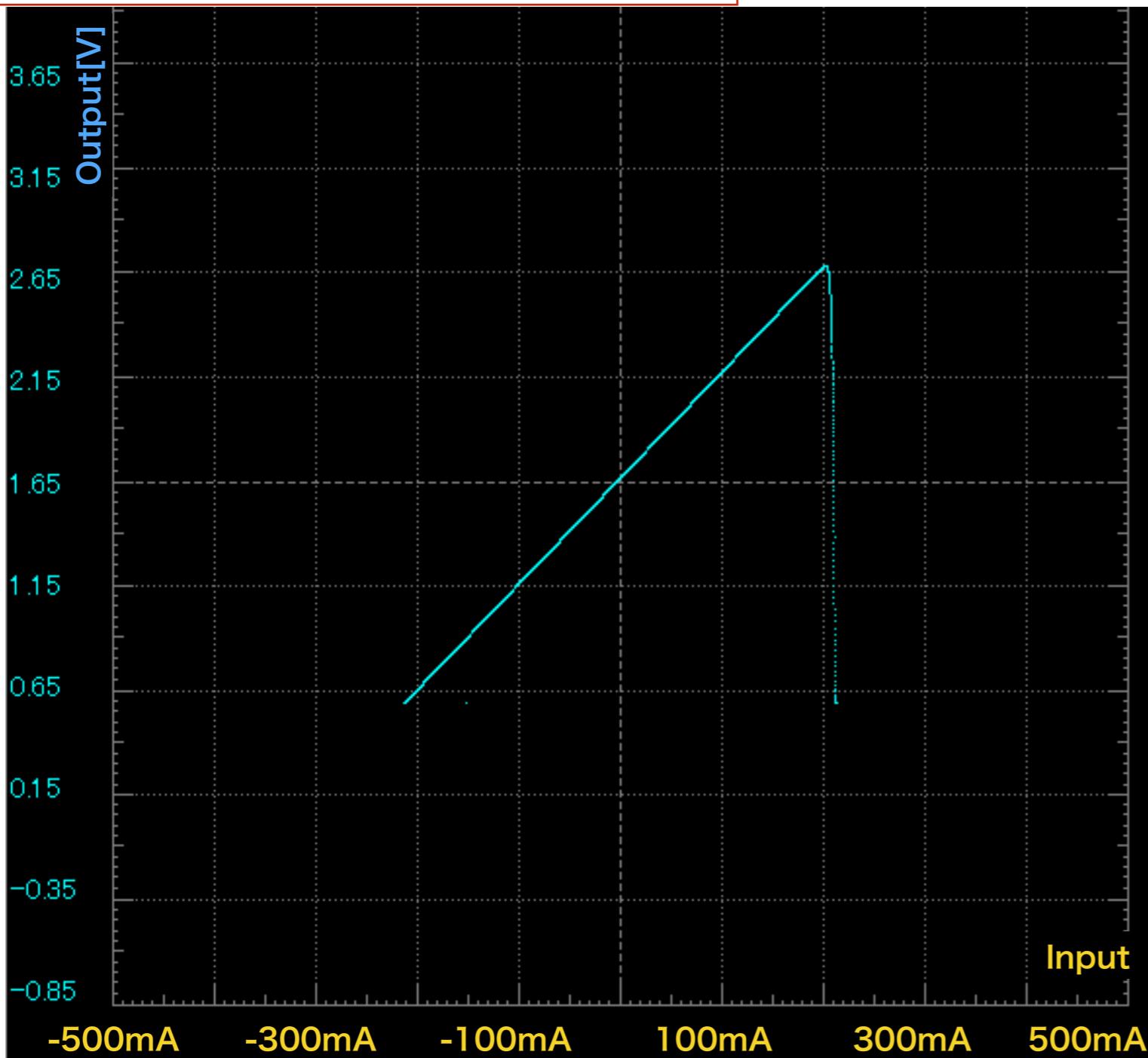
0mA ≈ 1.66V

±200mA ≈ 1.66V + 0.43

-0.38

Watchdog system  
異常検出・安全装置

Current shunt monitor Input-Output  
Characteristic



For High Power

R1:100mΩ

INA282 G:50

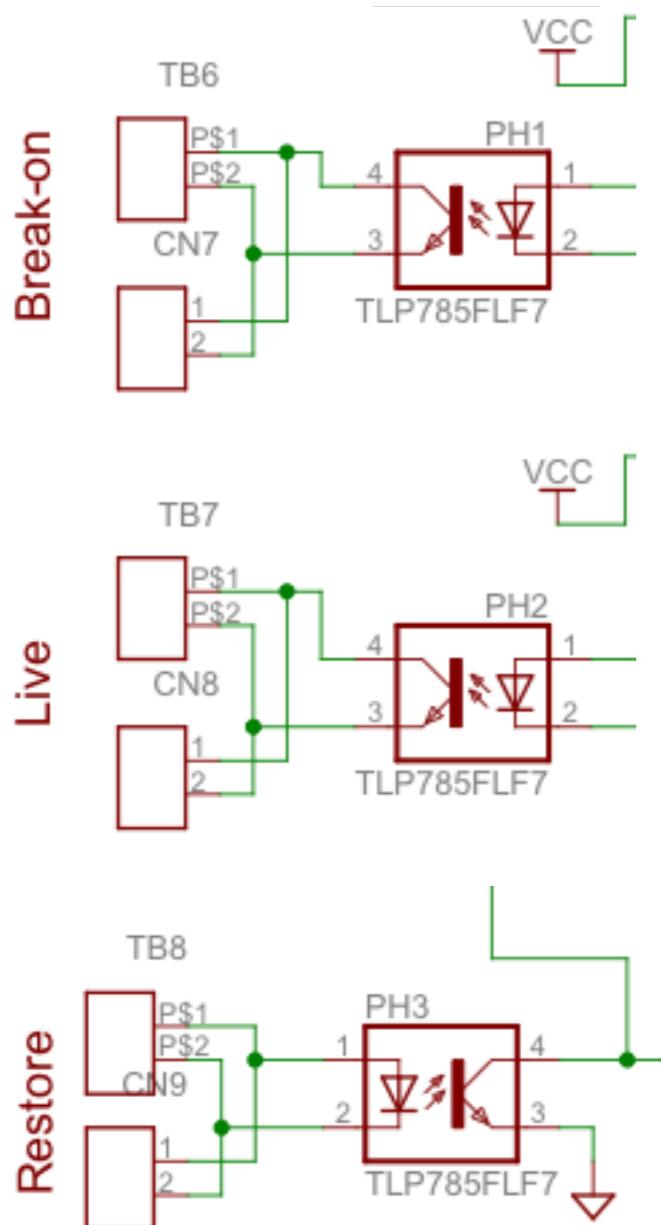
0mA ≈ 1.65V

±210mA ≈ 1.65V ± 1.05V

# Watchdog system

## 異常検出・安全装置

### Ex I/O(TLP785) data



**TOSHIBA**

TLP785,TLP785F

#### Current Transfer Ratio

Type	Classification (Note 1)	Current Transfer Ratio (%)		Marking of Classification	
		(I <sub>C</sub> / I <sub>F</sub> )			
		I <sub>F</sub> = 5mA, V <sub>CE</sub> = 5V, Ta = 25°C	Min Max		
TLP785	None	50	600	Blank	
	Rank Y	50	150	YE	
	Rank GR	100	300	GR	
	Rank BL	200	600	BL	
	Rank GB	100	600	GB	
	Rank YH	75	150	Y+	
	Rank GRL	100	200	G	
	Rank GRH	150	300	G+	
	Rank BLL	200	400	B	

(Note 1): Ex. rank GB: TLP785 (GB)

(Note 2): Application type name for certification test, please use standard product type name, i. e.  
TLP785 (GB): TLP785

#### Absolute Maximum Ratings (Ta = 25°C)

	Characteristic	Symbol	Rating	Unit
LED	Forward current	I <sub>F</sub>	60	mA
	Forward current derating (Ta ≥ 39 °C)	ΔI <sub>F</sub> / °C	-0.7	mA / °C
	Pulse forward current	I <sub>FP</sub>	1	A
	Power dissipation	P <sub>D</sub>	90	mW
	Power dissipation derating	ΔP <sub>D</sub> / °C	-0.9	mW / °C
	Reverse voltage	V <sub>R</sub>	5	V
Detector	Junction temperature	T <sub>j</sub>	125	°C
	Collector-emitter voltage	V <sub>CEO</sub>	80	V
	Emitter-collector voltage	V <sub>ECO</sub>	7	V
	Collector current	I <sub>C</sub>	50	mA
	Power dissipation (single circuit)	P <sub>C</sub>	150	mW
	Power dissipation derating (Ta ≥ 25°C)	ΔP <sub>C</sub> / °C	-1.5	mW / °C
	Junction temperature	T <sub>j</sub>	125	°C

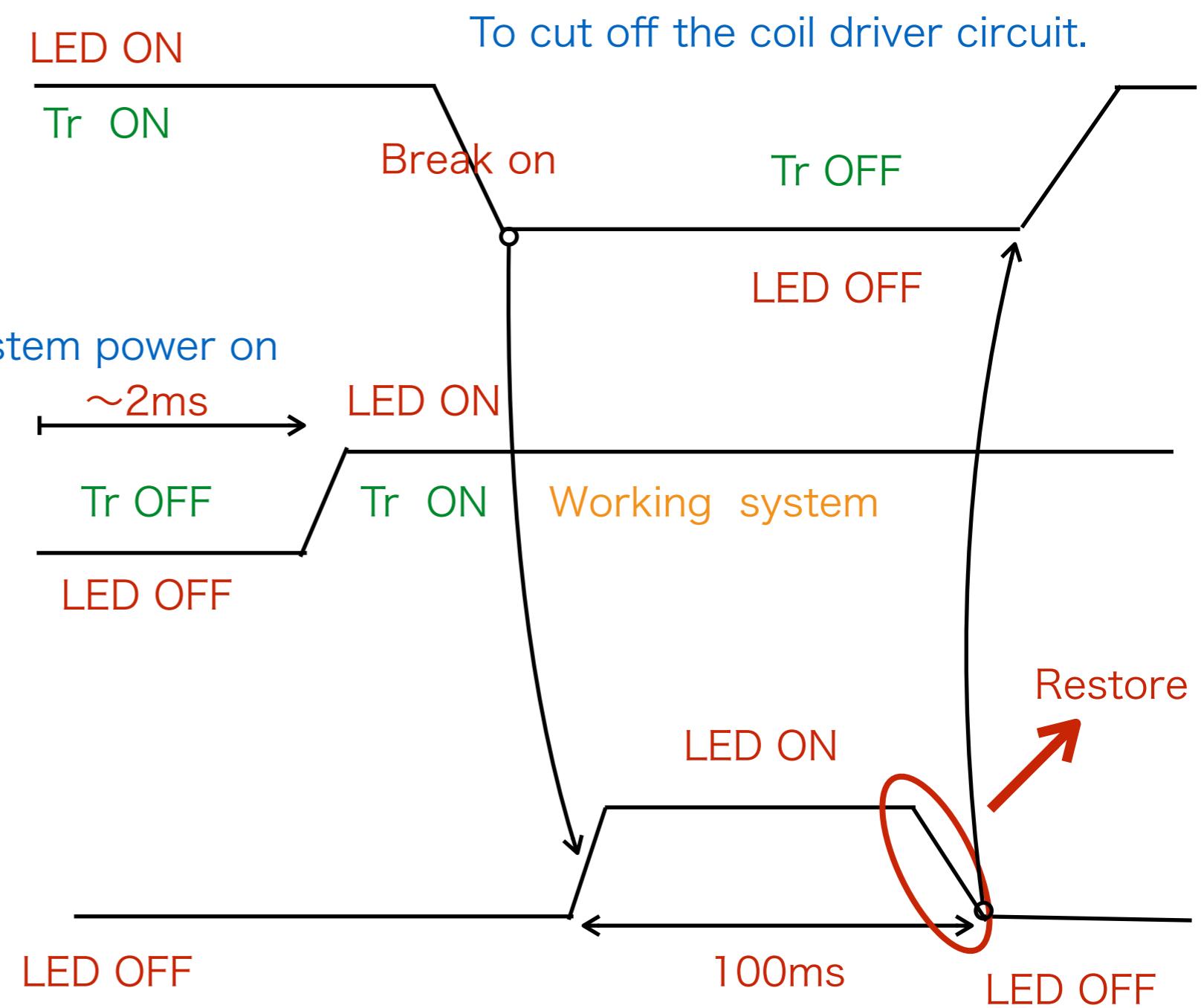
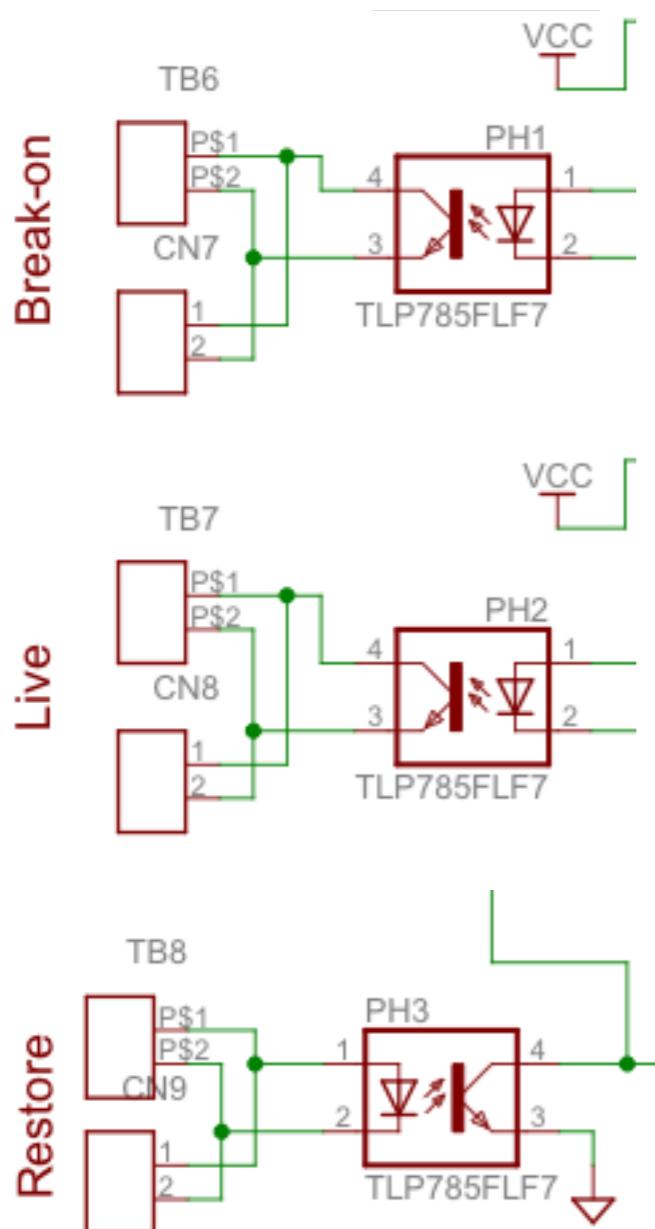
#### Recommended Operating Conditions (Note)

Characteristic	Symbol	Min	Typ.	Max	Unit
Supply voltage	V <sub>CC</sub>	—	5	24	V
Forward current	I <sub>F</sub>	—	16	25	mA
Collector current	I <sub>C</sub>	—	1	10	mA
Operating temperature	T <sub>opr</sub>	-25	—	85	°C

(Note): Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

# Watchdog system 異常検出・安全装置

## Ex I/O timing chart

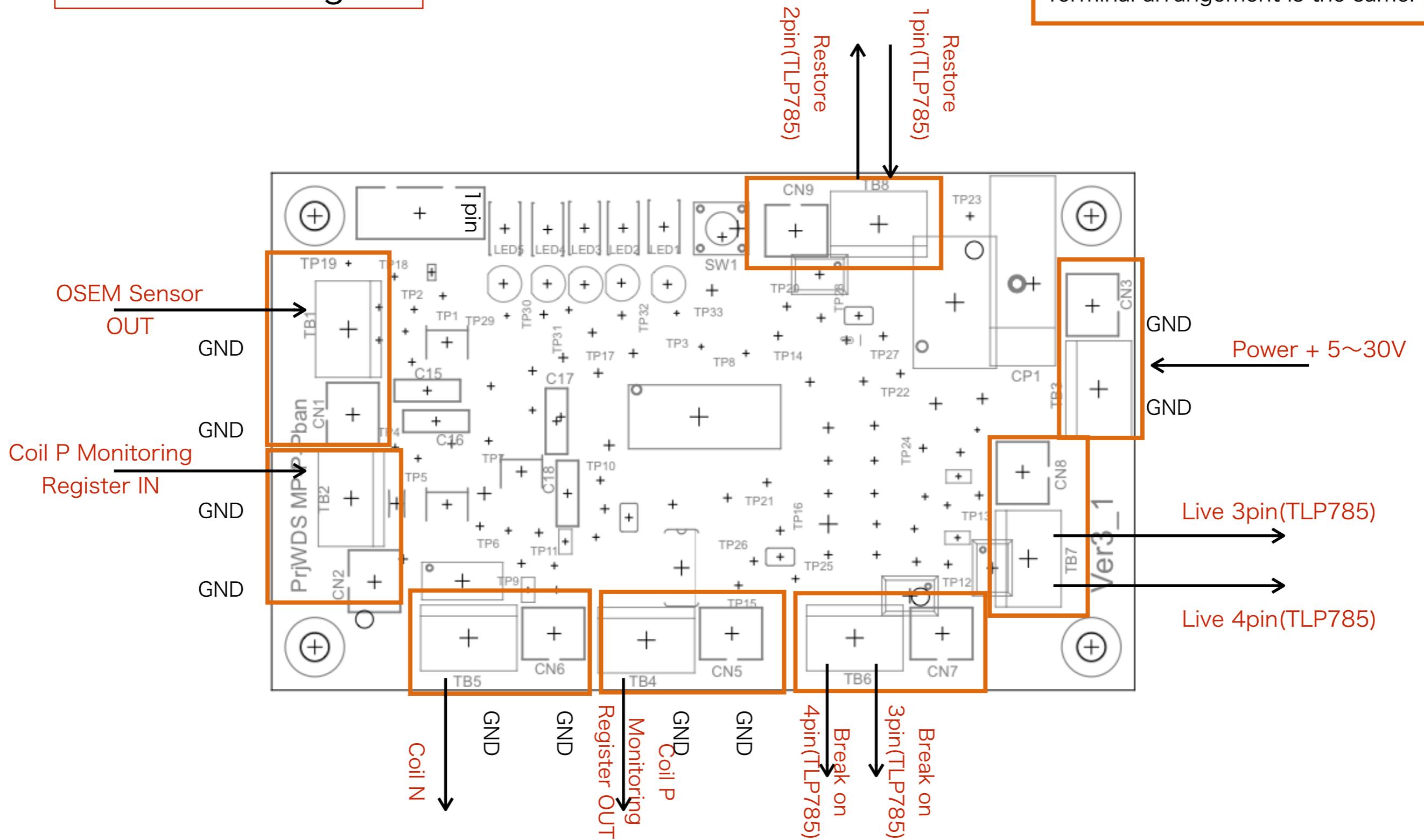


# Watchdog system

## 異常検出・安全装置

connection diagram

Terminal arrangement is the same.



# Watchdog system 異常検出・安全装置

## InterMPU WDT implementation

For Test

Interrupt

Main

Configuration  
FWDTEN = on//WDT enable  
WDTPS = PS65536 //WDT Postscale

H/W  
Manual Push or  
Ex Input(TLP765)

Int4

Interrupted handler

ClearEventWDS();

In fact S/W

ReadEventWDS();

DisableWDS();

ClearEventWDS();

...

EnableWDS();

While(1){

...

}

Configuration  
FWDTEN = on//WDT enable  
WDTPS = PS512 //WDT Postscale

While(1){

...

ClearEventWDS();

}